



A wide variety of transmissionline topologies and pcb-parameters like permittivity, substrate thickness, and board-stackup are applied by customers. These parameters have a strong impact on the high frequency performance of the mounted connector.
 Please note, that the given layout is not optimised to fit all of the possible board configurations regarding RF-performance, it represents a recommendation for optimum solderability of the connector.
 In order to guarantee optimum high frequency properties of the connector, an RF-analysis of the connector to board transition is recommended.

Zust. / Rev.	Änderung / Change
c00	Verweis auf Spezifische Stecker entfernt / removed annotation for specific plugs

Rosenberger			general tolerance		scale: 5:1	weight[g]:	
			ISO 2768	RN 006-01	material: . . .	surface[mm ²]:	
vertraulich / confidential			mH		title: <h2 style="text-align: center;">Montagebohrung</h2>		
			dimensions <0,5 and symmetry				
		date	name	drawing-no.: MB_355 sheet: 1 of: 1			
c00	18-2180	J_Frey	29.11.2018				
b00	13-0257	M_Kotewitz	11.03.2013				
a00	12-s244	M_Ruf	27.06.2012				
		dimensioning incl. plating		remarks: .			
300	11-0681	I_Sambale	03.08.2011				
200	10-v351	M_Pemwieser	12.11.2010				
100	10-m332	M_Pemwieser	07.06.2010	Size ISO 14405 (E) Tolerancing ISO 8015			
rev.	change-no	name	date				